

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10000252
FILING DATE 11/30/2001
CLASS 029
SUBCLASS 2812
GAU
EXAMINER Latta

**APPLICANTS: Dias Rajen; Chandran Biju;
438 460

**CONTINUING DATA VERIFIED:

** FOREIGN APPLICATIONS VERIFIED:

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PG-PUB ☐ DO NOT PUBLISH ☐ RESCIND ☐
Foreign priority claimed ☐ yes ☐ no
35 USC 119 conditions met ☐ yes ☐ no
Verified and Acknowledged Examiners' initials
ATTORNEY DOCKET NO 42390P13269

TITLE : Backside metallization on microelectronic dice having beveled sides for effective thermal contact with heat dissipation device
U.S. DEPT. OF COMM. / PAT. & TM. PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED

ISSUE FEE
Amount Due Date Paid

☐ TERMINAL
DISCLAIMER

Assistant Examiner

Primary Examiner

PREPARED FOR ISSUE

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CLAIMS ALLOWED

Total Claims Print Claim for O.G.
DRAWING
Sheets Drwg. Figs. Drwg. Print Fig.

Application Examiner

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☐ DISK (CRF) ☐ CD-ROM
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